

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Kwang Hee LEE	09/19/2008
Xavier BULLIARD	09/19/2008
Yi Yeol LYU	09/19/2008
Hyeon Jin SHIN	09/19/2008
Yun Hyuk CHOI	09/19/2008

RECEIVING PARTY DATA

Name:	Samsung Electronics Co., Ltd.
Street Address:	416, Maetan-dong, Yeongtong-gu
City:	Suwon-si, Gyeonggi-do
State/Country:	REPUBLIC OF KOREA
Postal Code:	442-742

Name:	Samsung Corning Precision Glass Co., Ltd.
Street Address:	12F Taepyungro B/D, 310
Internal Address:	Taepyunggro 2-Ga, Jung-Gu
City:	Seoul
State/Country:	REPUBLIC OF KOREA
Postal Code:	100-767

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	12241976

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PATENT

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PHO-0136

NAME OF SUBMITTER:

Dana A. Gronbeck

Total Attachments: 2

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ASSIGNMENT

WHEREAS We, **Kwang Hee LEE** of **115-1802, Byoksan Apt., Mangpo-dong, Yeongtong-gu, Suwon-si, Gyeonggi-do, 443-707 Republic of Korea**, **Xavier BULLIARD** of **Samsung Advanced Institute of Technology, Nongseo-dong, Giheung-gu, Yongin-si, Gyeonggi-do, 446-712 Republic of Korea**, **Yi Yeol LYU** of **252-1501, Kumho bestville 1-5 Danji Apt., Sanghyeon-dong, Suji-gu, Yongin-si, Gyeonggi-do, 448-515 Republic of Korea**, **Hyeon Jin SHIN** of **524-1801 Baekseol Maeul Jinro Apt., Jeongja 3-dong, Jangan-gu, Suwon-si, Gyeonggi-do, 440-719 Republic of Korea** and **Yun Hyuk CHOI** of **104-1203, Samsung Apt., Sindang 4-dong, Jung-gu, Seoul, 100-763 Republic of Korea** (hereinafter referred to as "ASSIGNORS"); have invented certain new and useful improvements in:

PROTECTIVE FILM AND ENCAPSULATION MATERIAL COMPRISING THE SAME

which claims priority to Korean Application No. 10-2008-0031873, filed on April 4, 2008, and for which We are about to file an application for Letters Patent of the United States;


AND WHEREAS, **SAMSUNG ELECTRONICS CO., LTD.** (hereinafter referred to as "ASSIGNEE"), a corporation organized and existing under the laws of the Country of Korea, having a place of business at **416, Maetan-dong, Yeongtong-gu, Suwon-si, Gyeonggi-do, 442-742, Republic of Korea**, and **SAMSUNG CORNING PRECISION GLASS CO., LTD.** (hereinafter referred to as "ASSIGNEE"), a corporation organized and existing under the laws of the Country of Korea, having a place of business at **12F Taepyungro B/D, 310 Taepyungro 2-Ga, Jung-Gu, Seoul, 100-767, Republic of Korea**, are desirous of acquiring an interest in the United States and all foreign countries, in and to the said invention and Letters Patent to be obtained therefor;

NOW THEREFORE, TO ALL WHOM IT MAY CONCERN, be it known that, for good and valuable consideration, the receipt of which is hereby acknowledged, We, the said ASSIGNORS have assigned and transferred, and hereby assign and transfer unto the said ASSIGNEE, the entire right, title and interest in and to said invention in the United States and

in all foreign countries, including priority rights, as fully set forth and described in said application; and We do hereby authorize and request the Commissioner of Patents to issue said Letters Patent on said application, and any and all Letters Patent that may be issued upon any and all revivals, refilings, continuations, continuations-in-part, divisions and reissues thereof, to the said ASSIGNEE, an assignee of the entire right, title and interest in and to the same, for the sole use and behoof of ASSIGNEE, its successors and assigns; and We do hereby agree that the said ASSIGNEE, may apply for foreign Letters Patent on said invention and that We will execute all papers necessary in connection with the United States and foreign applications when called upon to do so by the said ASSIGNEE, its successors or assigns, and that We will, at the cost and expense of the said ASSIGNEE fully assist and cooperate in all matters in connection with the United States and foreign applications and patents issuing thereon.

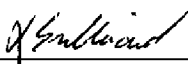
The undersigned declare that all statements made herein of their own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

Date: September 19, 2008



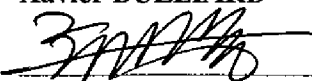
Kwang Hee LEE L.S.

Date: September 19, 2008




Xavier BULLIARD L.S.

Date: September 19, 2008



Yi Yeol LYU L.S.

Date: September 19, 2008



Hyeon Jin SHIN L.S.

Date: September 19, 2008



Yun Hyuk CHOI L.S.